

SLOVENSKI STANDARD

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Konektorji za elektronsko opremo - 7-3. del: Podrobna specifikacija za 8-redne, zaslonjene, proste in fiksne konektorje za prenos podatkov s frekvencami do 100 MHz (IEC 60603-7-3:2008)

Connectors for electronic equipment - Part 7-3: Detail specification for 8-way, shielded, free and fixed connectors, for data transmission with frequencies up to 100 MHz (IEC 60603-7-3:2008)

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Steckverbinder für elektronische Einrichtungen - Teil 7-3: Bauartspezifikation für geschirmte freie und feste Steckverbinder, 8polig, für Datenübertragungen bis 100 MHz (IEC 60603-7-3:2008)

[SIST EN 60603-7-3:2010](https://standards.iteh.ai/catalog/standards/sist/fb01ecef-7d75-4a3f-8fca-e3fca0ef4a1e/sist-en-60603-7-3-2010)

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Connecteurs pour équipements électroniques - Partie 7-3: Spécification particulière pour les fiches et les embases blindées à 8 voies pour la transmission de données à des fréquences jusqu'à 100 MHz (CEI 60603-7-3:2008)

Ta slovenski standard je istoveten z: EN 60603-7-3:2009

ICS:

31.220.10 Xcã ã Ácã } ã Æ [] ^ d !ã Plug-and-socket devices.
Connectors

SIST EN 60603-7-3:2010

en,fr

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EUROPEAN STANDARD
NORME EUROPÉENNE
EUROPÄISCHE NORM

EN 60603-7-3

November 2009

ICS 31.220.10

English version

**Connectors for electronic equipment -
Part 7-3: Detail specification for 8-way, shielded,
free and fixed connectors, for data transmissions
with frequencies up to 100 MHz
(IEC 60603-7-3:2008)**

Connecteurs pour équipements
électroniques -
Partie 7-3: Spécification particulière
pour les fiches et les embases
blindées à 8 voies
pour la transmission de données
à des fréquences jusqu'à 100 MHz
(CEI 60603-7-3:2008)

Steckverbinder für elektronische
Einrichtungen -
Teil 7-3: Bauartspezifikation
für geschirmte freie und feste
Steckverbinder, 8polig,
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This European Standard was approved by CENELEC on 2009-09-01. CENELEC members are bound to comply with the CEN/CENELEC Internal Regulations which stipulate the conditions for giving this European Standard the status of a national standard without any alteration.

Up-to-date lists and bibliographical references concerning such national standards may be obtained on application to the Central Secretariat or to any CENELEC member.

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CENELEC members are the national electrotechnical committees of Austria, Belgium, Bulgaria, Cyprus, the Czech Republic, Denmark, Estonia, Finland, France, Germany, Greece, Hungary, Iceland, Ireland, Italy, Latvia, Lithuania, Luxembourg, Malta, the Netherlands, Norway, Poland, Portugal, Romania, Slovakia, Slovenia, Spain, Sweden, Switzerland and the United Kingdom.

CENELEC

European Committee for Electrotechnical Standardization
Comité Européen de Normalisation Electrotechnique
Europäisches Komitee für Elektrotechnische Normung

Central Secretariat: Avenue Marnix 17, B - 1000 Brussels

Foreword

The text of document 48B/1816/FDIS, future edition 1 of IEC 60603-7-3, prepared by SC 48B, Connectors, of IEC TC 48, Electromechanical components and mechanical structures for electronic equipment, was submitted to the IEC-CENELEC parallel vote and was approved by CENELEC as EN 60603-7-3 on 2009-09-01.

The following dates were fixed:

- latest date by which the EN has to be implemented at national level by publication of an identical national standard or by endorsement (dop) 2010-06-01
- latest date by which the national standards conflicting with the EN have to be withdrawn (dow) 2012-09-01

Annex ZA has been added by CENELEC.

Endorsement notice

The text of the International Standard IEC 60603-7-3:2008 was approved by CENELEC as a European Standard without any modification.

In the official version, for Bibliography, the following notes have to be added for the standards indicated:

IEC 60068-2-14	NOTE	Harmonized as EN 60068-2-14:2009 (not modified).
IEC 60603-7-2	NOTE	Harmonized as EN 60603-7-2:2009 (not modified).

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Annex ZA (normative)

Normative references to international publications with their corresponding European publications

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE When an international publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
-	-	Communication cables - Specifications for test methods - Part 1-14: Electrical test methods - Coupling attenuation or screening attenuation of connecting hardware	EN 50289-1-14	- ¹⁾
IEC 60050-581	- ¹⁾	International Electrotechnical Vocabulary (IEV) - Part 581: Electromechanical components for electronic equipment	-	-
IEC 60068-1	- ¹⁾	Environmental testing - Part 1: General and guidance	EN 60068-1	1994 ²⁾
IEC 60068-2-38	- ¹⁾	Environmental testing - Part 2-38: Tests - Test Z/AD: Composite temperature/humidity cyclic test	EN 60068-2-38	2009 ²⁾
IEC 60169-16	- ¹⁾	Radio-frequency connectors - Part 16: R.F. coaxial connectors with inner diameter of outer conductor 7 mm (0,276 in) with screw coupling - Characteristic impedance 50 ohms (75 ohms) (type N)	-	-
IEC 60352	Series	Solderless connections	EN 60352	Series
IEC 60352-2	- ¹⁾	Solderless connections - Part 2: Crimped connections - General requirements, test methods and practical guidance	EN 60352-2	2006 ²⁾
IEC 60352-3	- ¹⁾	Solderless connections - Part 3: Solderless accessible insulation displacement connections - General requirements, test methods and practical guidance	EN 60352-3	1994 ²⁾
IEC 60352-4	- ¹⁾	Solderless connections - Part 4: Solderless non-accessible insulation displacement connections - General requirements, test methods and practical guidance	EN 60352-4	1994 ²⁾
IEC 60352-5	- ¹⁾	Solderless connections - Part 5: Press-in connections - General requirements, test methods and practical guidance	EN 60352-5	2008 ²⁾

¹⁾ Undated reference.

²⁾ Valid edition at date of issue.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 60352-6	- ¹⁾	Solderless connections - Part 6: Insulation piercing connections - General requirements, test methods and practical guidance	EN 60352-6	1997 ²⁾
IEC 60352-7	- ¹⁾	Solderless connections - Part 7: Spring clamp connections - General requirements, test methods and practical guidance	EN 60352-7	2002 ²⁾
IEC 60512	Series	Connectors for electronic equipment - Tests and measurements	EN 60512	Series
IEC 60512-1-100	- ¹⁾	Connectors for electronic equipment - Tests and measurements - Part 1-100: General - Applicable publications	EN 60512-1-100	2006 ²⁾
IEC 60603-7	Series	Connectors for electronic equipment - Part 7: Detail specifications for 8-way free and fixed connectors	EN 60603-7	Series
IEC 60664-1	- ¹⁾	Insulation coordination for equipment within low-voltage systems - Part 1: Principles, requirements and tests	EN 60664-1	2007 ²⁾
IEC 61076-1	2006	Connectors for electronic equipment - Product requirements - Part 1: Generic specification	EN 61076-1	2006
IEC 61156	Series	Multicore and symmetrical pair/quad cables for digital communications	-	-
IEC 61156-1	- ¹⁾	Multicore and symmetrical pair/quad cables for digital communications - Part 1: Generic specification	-	-
IEC 61156-2	- ¹⁾	Multicore and symmetrical pair/quad cables for digital communications - Part 2: Horizontal floor wiring - Sectional specification	-	-
IEC 61156-3	- ¹⁾	Multicore and symmetrical pair/quad cables for digital communications - Part 3: Work area cable - Sectional specification	-	-
IEC 61156-4	- ¹⁾	Multicore and symmetrical pair/quad cables for digital communications - Part 4: Riser cables - Sectional specification	-	-
IEC 61156-5	- ¹⁾	Multicore and symmetrical pair/quad cables for digital communications - Part 5: Symmetrical pair/quad cables with transmission characteristics up to 1 000 MHz - Horizontal floor wiring - Sectional specification	-	-
ISO/IEC 11801	2002	Information technology - Generic cabling for customer premises	-	-
ISO 1302	- ¹⁾	Geometrical Product Specifications (GPS) - Indication of surface texture in technical product documentation	EN ISO 1302	2002 ²⁾
ITU-T Recommendation G.117	- ¹⁾	Transmission aspects of unbalance about earth	-	-

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
ITU-T Recommendation K.20	2000 ³⁾	Resistibility of telecommunication equipment installed in a telecommunications centre to overvoltages and overcurrents	-	-
ITU-T Recommendation K.44	2000 ⁴⁾	Resistibility tests for telecommunication equipment exposed to overvoltages and overcurrents - Basic Recommendation	-	-
ITU-T Recommendation O.9	- ¹⁾	Measuring arrangements to assess the degree of unbalance about earth	-	-

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³⁾ ITU-T Recommendation K.20 is superseded by ITU-T Recommendation K.20:2003 but for the purpose of this standard, the 2000 edition applies.

⁴⁾ ITU-T Recommendation K.44 is superseded by ITU-T Recommendation K.44:2003 but for the purpose of this standard, the 2000 edition applies.

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IEC 60603-7-3

Edition 1.0 2008-01

INTERNATIONAL STANDARD

NORME INTERNATIONALE

**Connectors for electronic equipment –
Part 7-3: Detail specification for 8-way, shielded, free and fixed connectors, for
data transmissions with frequencies up to 100 MHz**

**Connecteurs pour équipements électroniques –
Partie 7-3: Spécification particulière pour les fiches et les embases blindées à
8 voies pour la transmission de données à des fréquences jusqu'à 100 MHz**

INTERNATIONAL
ELECTROTECHNICAL
COMMISSION

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INTERNATIONALE

PRICE CODE
CODE PRIX

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

CONNECTORS FOR ELECTRONIC EQUIPMENT –**Part 7-3: Detail specification for 8-way, shielded,
free and fixed connectors, for data transmissions
with frequencies up to 100 MHz**

FOREWORD

- 1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
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International Standard IEC 60603-7-3 has been prepared by subcommittee 48B: Connectors, of IEC technical committee 48: Electromechanical components and mechanical structures for electronic equipment.

This standard cancels and replaces IEC/PAS 60603-7-3 published in 2004. This first edition constitutes a technical revision.

The text of this standard is based on the following documents:

FDIS	Report on voting
48B/1816/FDIS	48B/1835/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts of the IEC 60603-7 series, under the general title *Connectors for electronic equipment*, can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the maintenance result date indicated on the IEC web site under "http://webstore.iec.ch" in the data related to the specific publication. At this date, the publication will be

- reconfirmed;
- withdrawn;
- replaced by a revised edition, or
- amended.

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